

2.5V Drive Nch MOSFET

RJU003N03

●Structure

Silicon N-channel MOSFET

●Features

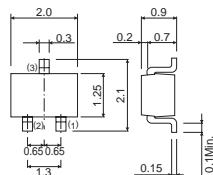
- 1) Low On-resistance.
- 2) Low voltage drive (2.5V drive).

●Applications

Switching

●Dimensions (Unit : mm)

UMT3



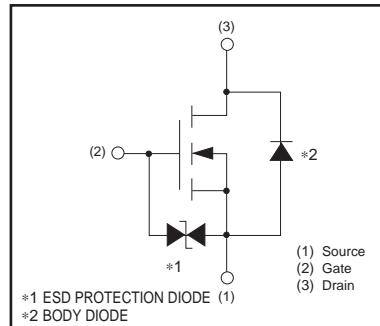
(1) Source
(2) Gate
(3) Drain

Each lead has same dimensions
Abbreviated symbol : LP

●Packaging specifications and h_{FE}

| Type | Package | Taping |
|-----------|------------------------------|--------|
| | Code | T106 |
| | Basic ordering unit (pieces) | 3000 |
| RJU003N03 | ○ | |

●Inner circuit



●Absolute maximum ratings (Ta=25°C)

| Parameter | Symbol | Limits | Unit |
|------------------------------|-------------|-------------|------|
| Drain-source voltage | V_{DSS} | 30 | V |
| Gate-source voltage | V_{GSS} | ± 12 | V |
| Drain current | I_D | ± 300 | mA |
| Pulsed | I_{DP} *1 | ± 1.2 | A |
| Total power dissipation | P_D *2 | 200 | mW |
| Channel temperature | T_{ch} | 150 | °C |
| Range of storage temperature | T_{stg} | -55 to +150 | °C |

*1 $P_w \leq 10\mu s$, Duty cycle $\leq 1\%$

*2 Each terminal mounted on a recommended land

●Thermal resistance

| Parameter | Symbol | Limits | Unit |
|--------------------|------------------|--------|------|
| Channel to ambient | $R_{th(ch-a)}$ * | 625 | °C/W |

* Each terminal mounted on a recommended land

●Electrical characteristics (Ta=25°C)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|-----------------------------------------|-----------------------|------|------|----------|----------|-----------------------------------|
| Gate-source leakage | I_{GSS} | — | — | ± 10 | μA | $V_{GS}=\pm 12V, V_{DS}=0V$ |
| Drain-source breakdown voltage | $V_{(BR) DSS}$ | 30 | — | — | V | $I_D= 1mA, V_{GS}=0V$ |
| Zero gate voltage drain current | I_{DSS} | — | — | 1 | μA | $V_{DS}= 30V, V_{GS}=0V$ |
| Gate threshold voltage | $V_{GS(\text{th})}$ | 0.8 | — | 1.5 | V | $V_{DS}= 10V, I_D= 1mA$ |
| Static drain-source on-state resistance | $R_{DS(\text{on})}^*$ | — | 0.8 | 1.1 | Ω | $I_D= 300mA, V_{GS}= 4.5V$ |
| | | — | 0.9 | 1.3 | Ω | $I_D= 300mA, V_{GS}= 4V$ |
| | | — | 1.4 | 1.9 | Ω | $I_D= 300mA, V_{GS}= 2.5V$ |
| Forward transfer admittance | $ Y_{fs} ^*$ | 0.4 | — | — | S | $V_{DS}= 10V, I_D= 300mA$ |
| Input capacitance | C_{iss} | — | 24 | — | pF | $V_{DS}= 10V$ |
| Output capacitance | C_{oss} | — | 11 | — | pF | $V_{GS}=0V$ |
| Reverse transfer capacitance | C_{rss} | — | 5 | — | pF | $f=1MHz$ |
| Turn-on delay time | $t_d(\text{on})^*$ | — | 6 | — | ns | $V_{DD}= 15V$ |
| Rise time | t_r^* | — | 4 | — | ns | $I_D= 150mA$ |
| Turn-off delay time | $t_d(\text{off})^*$ | — | 9 | — | ns | $V_{GS}= 4V$ |
| Fall time | t_f^* | — | 32 | — | ns | $R_L=100\Omega$ $R_G=10\Omega$ |

*Pulsed

●Body diode characteristics (Source-drain) (Ta=25°C)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|-----------------|----------|------|------|------|------|-------------------------|
| Forward voltage | V_{SD} | — | — | 1.2 | V | $I_S= 200mA, V_{GS}=0V$ |

●Electrical characteristics curves

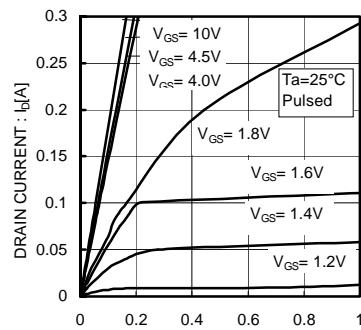


Fig.1 Typical Output Characteristics (I)

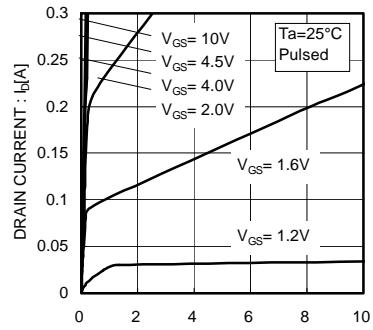


Fig.2 Typical Output Characteristics (II)

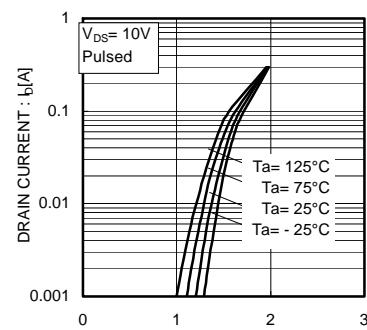


Fig.3 Typical Transfer Characteristics

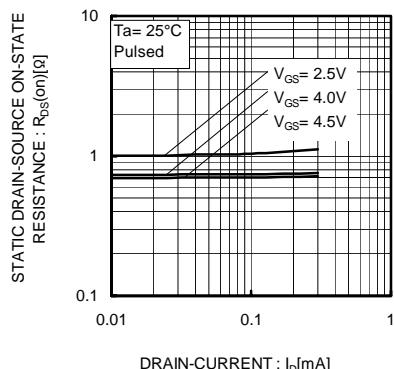


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (I)

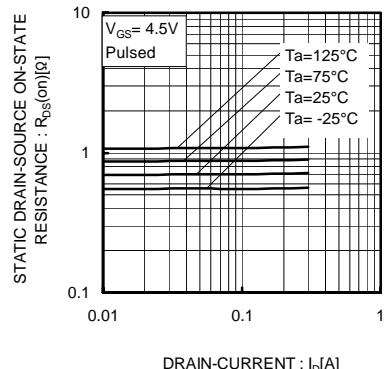


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current (II)

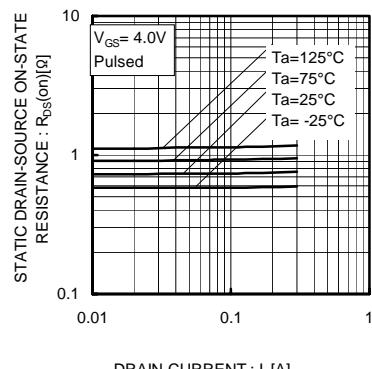


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current (III)

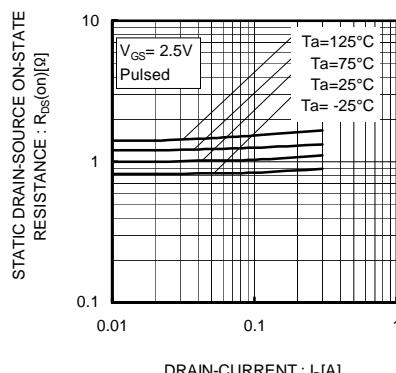


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (IV)

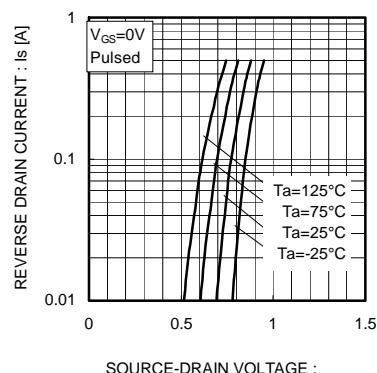


Fig.8 Reverse Drain Current vs. Source-Drain Voltage

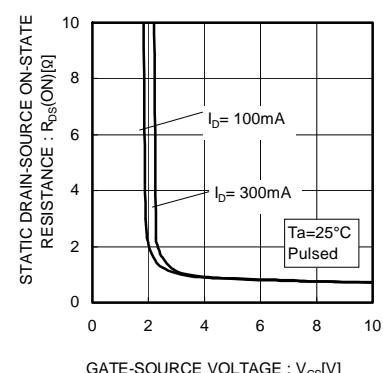


Fig.9 Static Drain-Source On-State Resistance vs. Gate Source Voltage

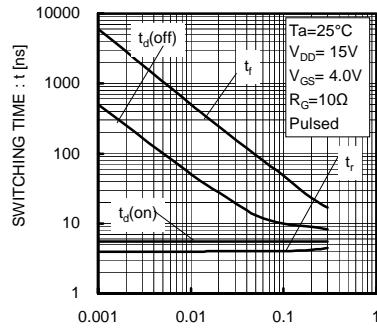
DRAIN-CURRENT : I_D [A]

Fig.10 Switching Characteristics

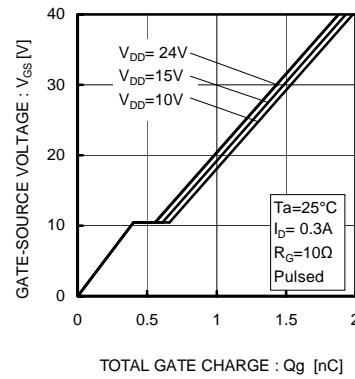
TOTAL GATE CHARGE : Q_g [nC]

Fig.11 Dynamic Input Characteristics

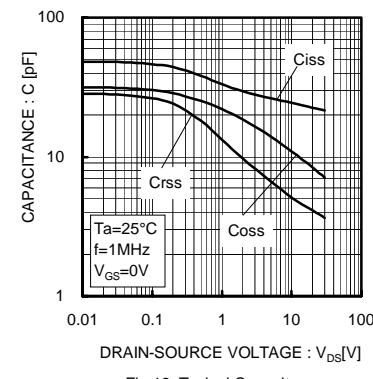
DRAIN-SOURCE VOLTAGE : V_{DS} [V]

Fig.12 Typical Capacitance vs. Drain-Source Voltage

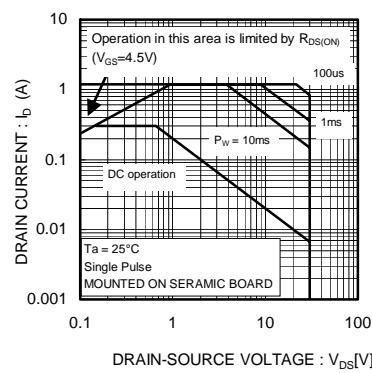
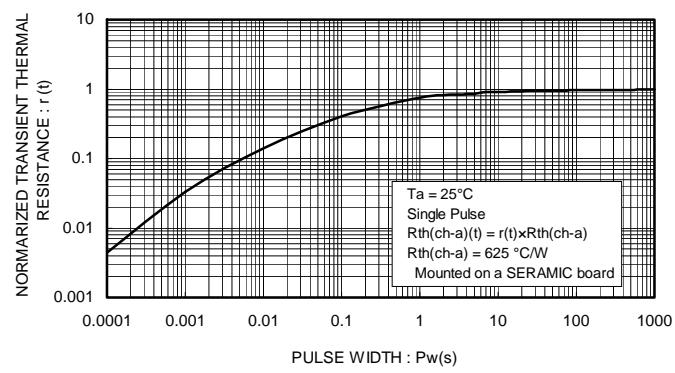
DRAIN-SOURCE VOLTAGE : V_{DS} [V]

Fig.13 Maximum Safe Operating Area

NORMAIZED TRANSIENT THERMAL RESISTANCE : $r(t)$ PULSE WIDTH : P_w (s)

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